



Substrate Integrated Waveguide (SIW) and Its Applications II

Guest Editor:

Prof. Dr. Francesco Prudeniano

Department of Electrical Engineering and Information, Entries Polytechnic University of Bari, Via Orabona, 4-70125 Bari, Italy

Deadline for manuscript submissions:
closed (20 May 2022)

Message from the Guest Editor

Dear Colleagues,

During the last decade, substrate integrated waveguide (SIW) technology has been largely implemented for the construction of numerous microwave devices and circuits based on innovative solutions or re-proposing, by following a quasi-planar approach, well-known functionalities of classical waveguide-based components/systems. The possibility of fabricating shielded structures by employing planar geometries has provided an amazing way to fabricate innovative resonators exhibiting very high quality factors suitable for filter and oscillator applications, efficient radiating structures. Multi-layered printed circuit board (PCB) or low-temperature co-fired ceramic (LTCC) technologies and the SIW approach allow a high feasibility, planar integration and packaging degree to be reached. As a consequence, the possibility of fabricating complex structures at low cost fulfils the increasing demand of highly sophisticated antennas for satellite communication, 5G and new generation wireless systems, terahertz systems, biomedicine, and a number of other applications.

Prof. Dr. Francesco Prudeniano
Guest Editor





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility: indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, Embase, CAPlus / SciFinder, and other databases.

Journal Rank: JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

Contact Us

Applied Sciences Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/applsci
applsci@mdpi.com
[X@Applsci](https://twitter.com/AtApplsci)